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#### 20V P-Channel Enhancement Mode MOSFET – ESD Protected SOT-563 Unit : inch(mm) Voltage -20 V Current -0.6A 0.006(0.17) Features 0.044(1.10)0.035(0.90)0.067(1.70) 0.059(1.50) RDS(ON), VGS@-4.5V, ID@-0.6A<340mΩ</li> RDS(ON), VGS@-2.5V, ID@-0.4A<420mΩ 0.052(1.30) 0.024(0.60) 0.043(1.10) 0.067(1.70) 0.019(0.50) RDS(ON), VGS@-1.8V, ID@-0.2A<600mΩ . 0.059(1.50) Advanced Trench Process Technology 0.007(0.17) Specially Designed for Switch Load, PWM Application, etc. ESD Protected • Lead free in compliance with EU RoHS 2011/65/EU directive Green molding compound as per IEC61249 Std. 0.012(0.30) (Halogen Free) D1 G2 **S**2 **Mechanical Data** 6 5 4 • Case: SOT-563 Package Terminals: Solderable per MIL-STD-750, Method 2026 • Approx. Weight: 0.00009 ounces, 0.0026 grams 3

Marking: X03

### **Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25<sup>°</sup>C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS
Drain-Source Voltage		V <sub>DS</sub>	-20	V
Gate-Source Voltage		V <sub>GS</sub>	<u>+</u> 8	V
Continuous Drain Current		I <sub>D</sub>	-0.6	А
Pulsed Drain Current		I <sub>DM</sub>	-2.4	А
Power Dissipation	T <sub>a</sub> =25°C	P <sub>D</sub>	300	mW
	Derate above 25°C		2.4	mW/°C
Operating Junction and Storage Temperature Range		T <sub>J</sub> ,T <sub>STG</sub>	-55~150	°C
Typical Thermal resistance - Junction to Ambient <sup>(Note 3)</sup>		R <sub>eJA</sub>	417	°C/W

2

G

D2



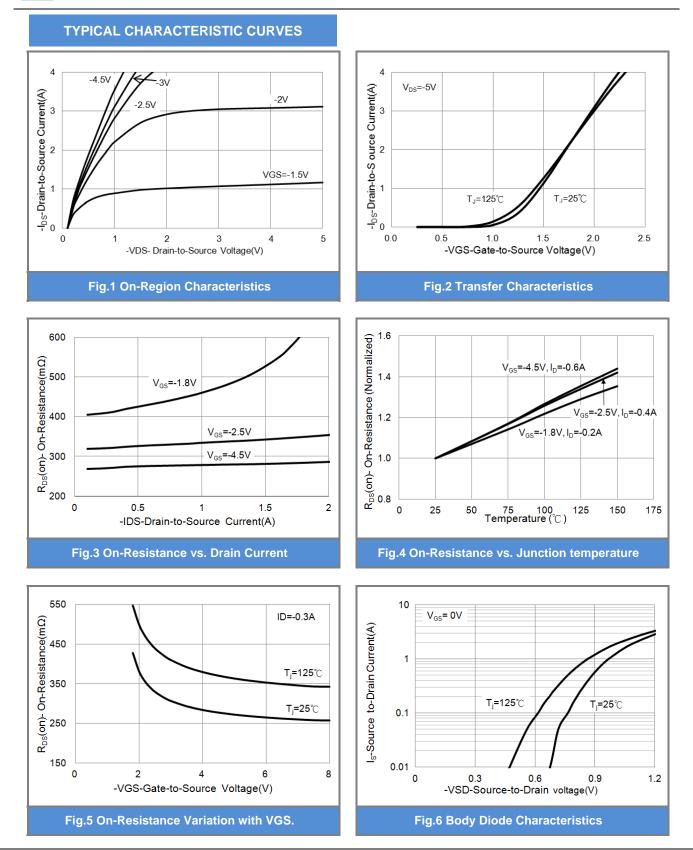
## **Electrical Characteristics** ( $T_A=25^{\circ}C$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static					L	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA	-20	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_{D}=-250$ uA	-0.4	-0.64	-1.0	V
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-0.6A	-	280	340	
Drain-Source On-State Resistance	$R_{\text{DS(on)}}$	V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-0.4A	-	330	420	mΩ
		V <sub>GS</sub> =-1.8V, I <sub>D</sub> =-0.2A	-	420	600	-
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V	-	-0.01	-1	uA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = <u>+</u> 8V, V <sub>DS</sub> =0V	-	<u>+</u> 3.5	<u>+</u> 10	uA
Dynamic						
Total Gate Charge	Qg		-	2.2	-	nC
Gate-Source Charge	$Q_gs$	V <sub>DS</sub> =-10V, I <sub>D</sub> =-0.6A, V <sub>GS</sub> =-4.5V <sup>(Note 1,2)</sup>	-	0.4	-	
Gate-Drain Charge	$Q_gd$	V <sub>GS</sub> 4.5V	-	0.5	-	
Input Capacitance	Ciss		-	151	-	pF
Output Capacitance	Coss	$V_{DS}$ =-10V, $V_{GS}$ =0V,	-	27	-	
Reverse Transfer Capacitance	Crss	f=1.0MHZ	-	9	-	
Switching						
Turn-On Delay Time	td <sub>(on)</sub>		-	9	-	
Turn-On Rise Time	tr	$V_{DD}$ =-10V, $I_{D}$ =-0.6A, $V_{GS}$ =-4.5V, $R_{G}$ =6 $\Omega$ <sup>(Note 1,2)</sup>	-	37	-	ns
Turn-Off Delay Time	td <sub>(off)</sub>		-	128	-	
Turn-Off Fall Time	tf	R <sub>G</sub> =012	-	72	-	
Drain-Source Diode						
Maximum Continuous Drain-Source					-0.4	A
Diode Forward Current	I <sub>S</sub>		-	-	-0.4	A
Diode Forward Voltage	$V_{SD}$	I <sub>S</sub> =-1A, V <sub>GS</sub> =0V		-0.95	-1.2	v

NOTES :

- 1. Pulse width300us, Duty cycle2%
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Reja is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper
- 4. The maximum current rating is package limited







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**TYPICAL CHARACTERISTIC CURVES** 

Fig.7 Gate-Charge Characteristics

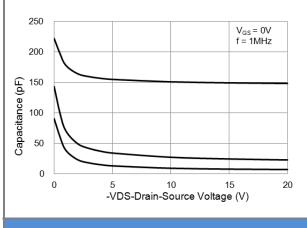
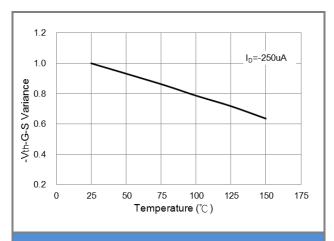


Fig.9 Capacitance vs. Drain-Source Voltage.





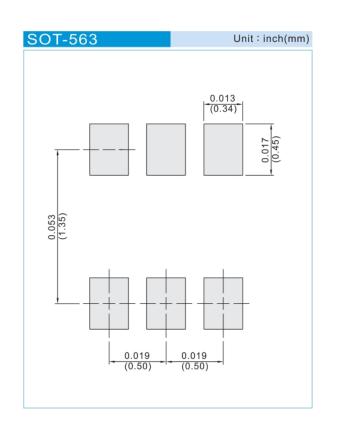




#### PART NO PACKING CODE VERSION

Part No Packing Code	Package Type	Packing type	Marking	Version
PJX8803_R1_00001	SOT-563	4K pcs / 7" reel	X03	Halogen free
PJX8803_R2_00001	SOT-563	10K pcs / 13" reel	X03	Halogen free

### MOUNTING PAD LAYOUT







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